

N-Channel 1.8-V (G-S) MOSFET

RSE23MU6T

FEATURES

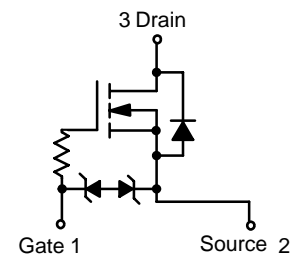
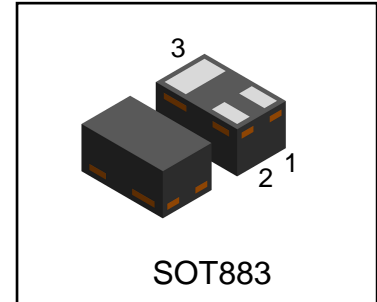
- TrenchFET® Power MOSFET: 1.8-V Rated
- Gate-Source ESD Protected: 2000 V
- High-Side Switching
- Low On-Resistance: 0.7 Ω
- Low Threshold: 0.8 V (typ)
- Fast Switching Speed: 10 ns
- S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

BENEFITS

- Ease in Driving Switches
- Low Offset (Error) Voltage
- Low-Voltage Operation
- High-Speed Circuits
- Low Battery Voltage Operation

APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- Battery Operated Systems
- Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers



ORDERING INFORMATION

| Device | Marking | Shipping |
|-----------|---------|-----------------|
| RSE23MU6T | A2 | 10000/Tape&Reel |

| ABSOLUTE MAXIMUM RATINGS (T _A = 25°C UNLESS OTHERWISE NOTED) | | | | | |
|---|-----------------------|-----------------------------------|------------|--------------|------|
| Parameter | | Symbol | 5 secs | Steady State | Unit |
| Drain-Source Voltage | | V _{DS} | 20 | | V |
| Gate-Source Voltage | | V _{GS} | ±6 | | |
| Continuous Drain Current (T _J = 150°C) ^b | T _A = 25°C | I _D | 600 | 500 | mA |
| | T _A = 85°C | | 400 | 350 | |
| Pulsed Drain Current ^a | | I _{DM} | 1000 | | |
| Continuous Source Current (diode conduction) ^b | | I _S | 275 | 250 | |
| Maximum Power Dissipation ^b | T _A = 25°C | P _D | | 250 | mW |
| Thermal Resistance, Junction to Ambient | | R _{θJA} | | 500 | °C/W |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to 150 | | °C |
| Gate-Source ESD Rating (HBM, Method 3015) | | ESD | 2000 | | V |

a. Pulse width limited by maximum junction temperature.
b. Surface Mounted on FR4 Board.

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| SPECIFICATIONS (T _A = 25 °C UNLESS OTHERWISE NOTED) | | | | | | |
|--|---------------------|---|------|------|------|------|
| Parameter | Symbol | Test Condition | Min | Typ | Max | Unit |
| Static | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250 μA | 0.45 | | 0.9 | V |
| Gate-Body Leakage | I _{GSS} | V _{DS} = 0 V, V _{GS} = ±4.5 V | | ±0.5 | ±1.0 | μA |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 20 V, V _{GS} = 0 V | | 0.3 | 100 | nA |
| | | V _{DS} = 20 V, V _{GS} = 0 V, T _J = 85 °C | | | 5 | μA |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} = 5 V, V _{GS} = 4.5 V | 700 | | | mA |
| Drain-Source On-State Resistance ^a | r _{DS(on)} | V _{GS} = 4.5 V, I _D = 600 mA | | 0.41 | 0.70 | Ω |
| | | V _{GS} = 2.5 V, I _D = 500 mA | | 0.53 | 0.85 | |
| | | V _{GS} = 1.8 V, I _D = 350 mA | | 0.70 | 1.25 | |
| Forward Transconductance ^a | g _{fs} | V _{DS} = 10 V, I _D = 400 mA | | 1.0 | | S |
| Diode Forward Voltage ^a | V _{SD} | I _S = 150 mA, V _{GS} = 0 V | | 0.8 | 1.2 | V |
| Dynamic^b | | | | | | |
| Total Gate Charge | Q _g | V _{DS} = 10 V, V _{GS} = 4.5 V, I _D = 250 mA | | 750 | | pC |
| Gate-Source Charge | Q _{gs} | | | 75 | | |
| Gate-Drain Charge | Q _{gd} | | | 225 | | |
| Turn-On Delay Time | t _{d(on)} | V _{DD} = 10 V, R _L = 47 Ω I _D ≅ 200 mA, V _{GEN} = 4.5 V, R _G = 10 Ω | | 5 | | ns |
| Rise Time | t _r | | | 5 | | |
| Turn-Off Delay Time | t _{d(off)} | | | 25 | | |
| Fall Time | t _f | | | 11 | | |

Notes

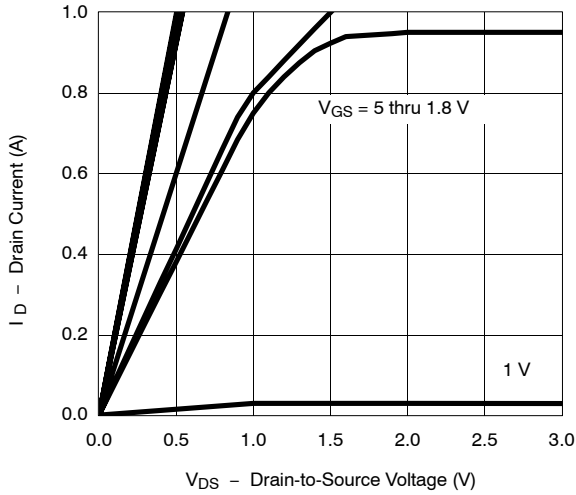
- c. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
d. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

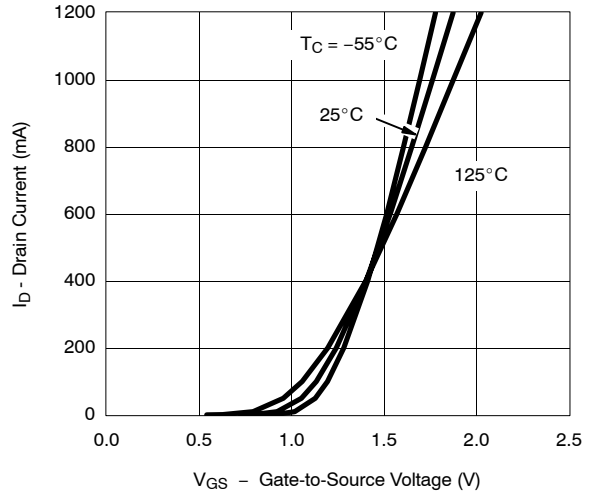
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TYPICAL CHARACTERISTICS (T_A = 25 °C UNLESS NOTED)

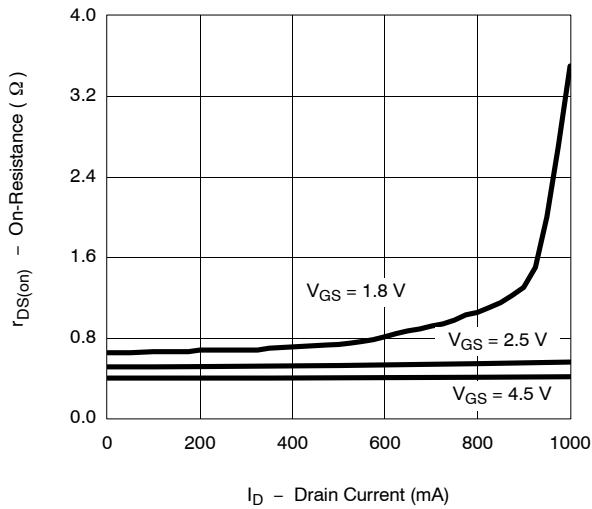
Output Characteristics



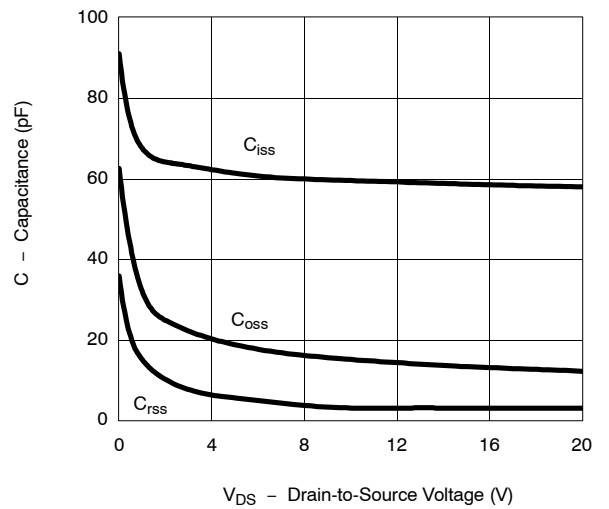
Transfer Characteristics



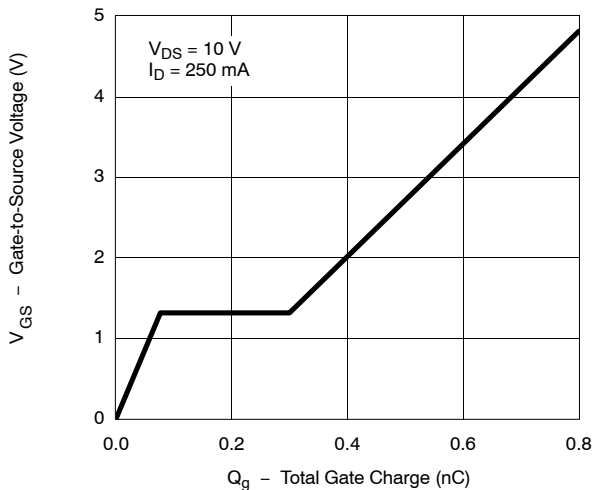
On-Resistance vs. Drain Current



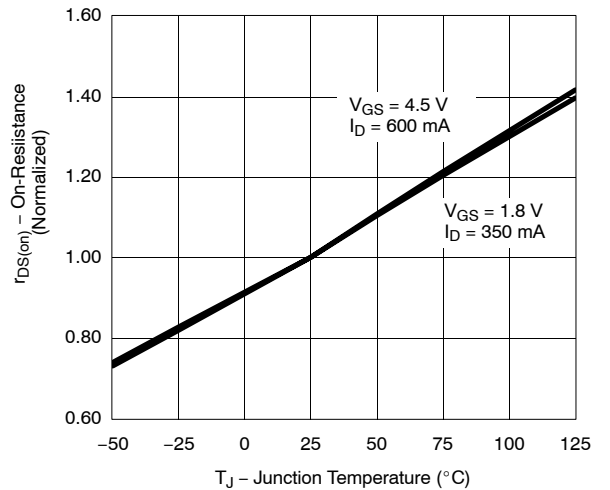
Capacitance



Gate Charge



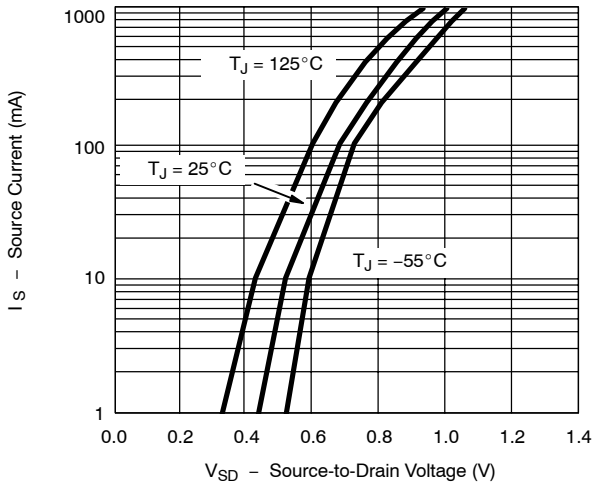
On-Resistance vs. Junction Temperature



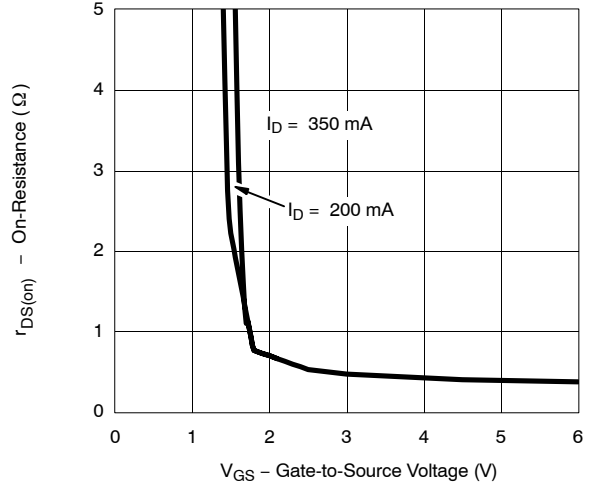
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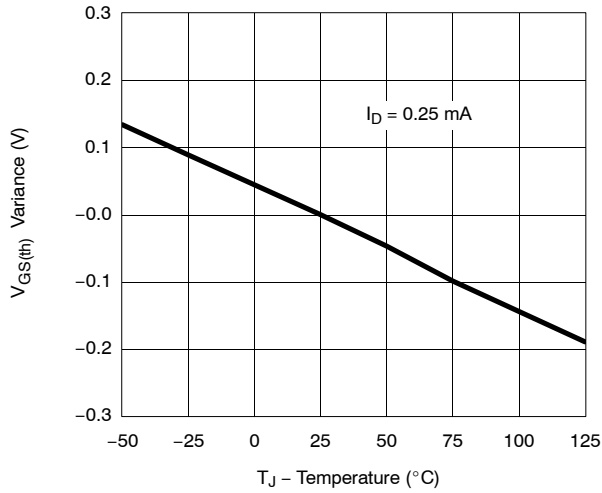
Source-Drain Diode Forward Voltage



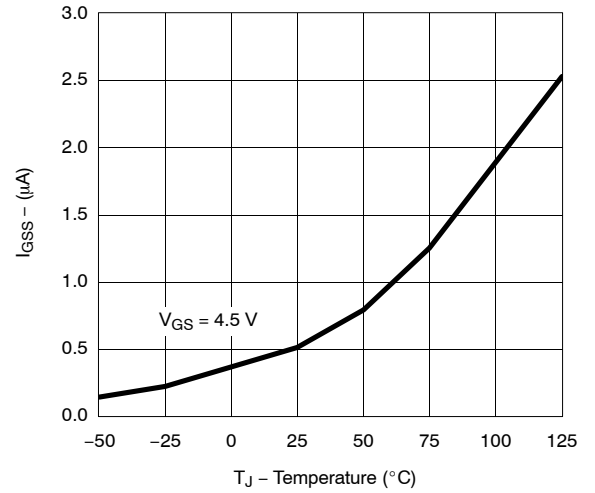
On-Resistance vs. Gate-to-Source Voltage



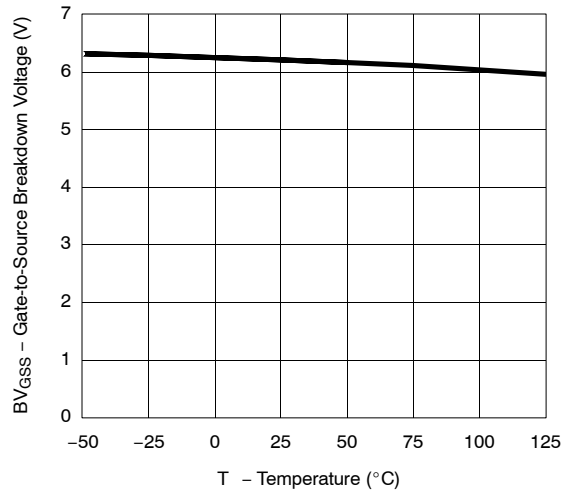
Threshold Voltage Variance vs. Temperature



I_GSS vs. Temperature



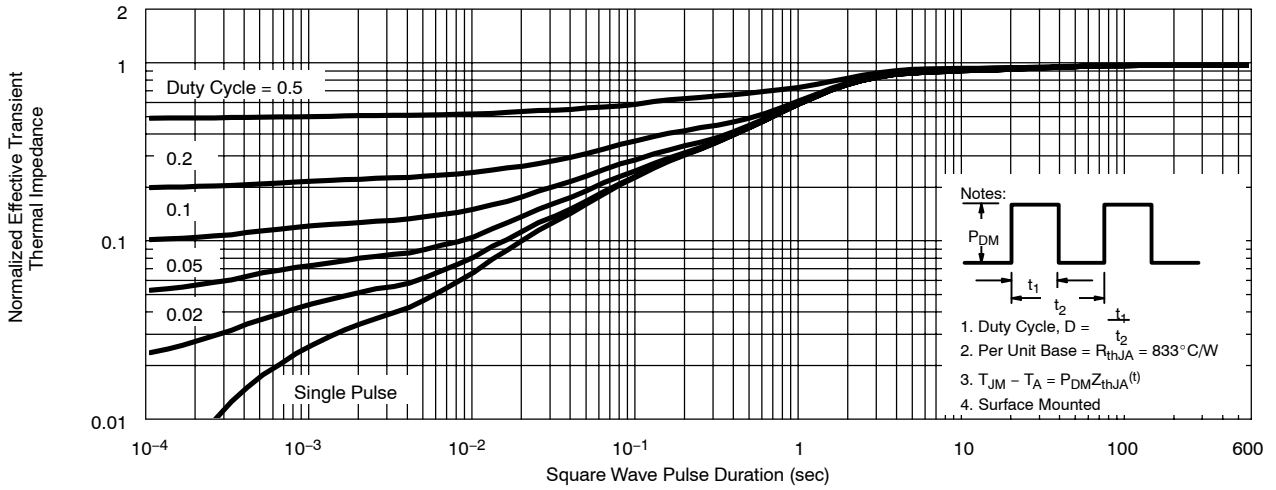
BV_GSS vs. Temperature



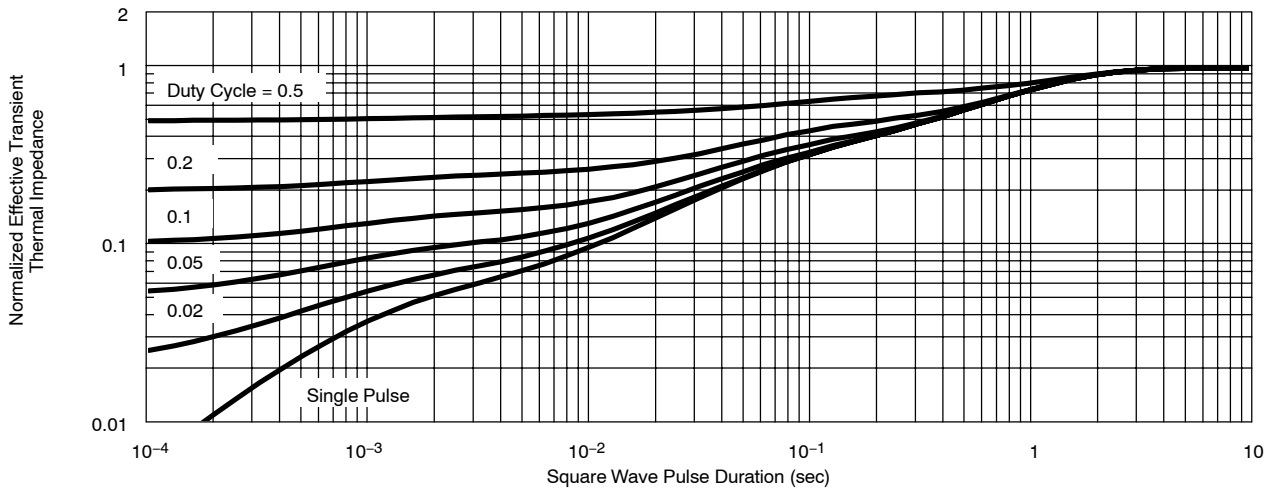
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TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ UNLESS NOTED)

Normalized Thermal Transient Impedance, Junction-to-Ambient (SC-75A)



Normalized Thermal Transient Impedance, Junction-to-Foot



RSE23MU6T

SOT883

DIMENSION OUTLINE:

Unit:mm

